High Performance, 145 MHz Fast FET ${ }^{\text {m" }}$ Op Amps AD8065/AD8066*

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FEATURES
FET Input Amplifier
1 \text { pA Input Bias Current}
Low Cost
High Speed
    145 MHz, -3 dB Bandwidth (G = +1)
180 V/ms Slew Rate (G = +2)
Low Noise
    7 nV/\sqrt{}{\textrm{Hz}}(\textrm{f}=10\textrm{kHz})
    0.6 fA/\sqrt{}{Hz}(f=10 kHz)
Wide Supply Voltage Range
    5V to 24V
Single-Supply and Rail-to-Rail Output
Low Offset Voltage 1.5 mV Max
High Common-Mode Rejection Ratio
-100 dB
Excellent Distortion Specifications
SFDR -88 dB @ 1 MHz
Low Power
    6.4 mA/Amplifier Typical Supply Current
No Phase Reversal
Small Packaging
    SOIC-8, SOT-23-5, and MSOP
APPLICATIONS
Instrumentation
Photodiode Preamp
Filters
A/D Driver
Level Shifting
Buffering
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## GENERAL DESCRIPTION

The AD8065/AD8066 Fast FET amplifiers are voltage feedback amplifiers with FET inputs offering very high performance and ease of use. The AD8065 is a single amplifier and the AD8066 is a dual amplifier. The Fast FET amplifiers in ADI's proprietary XFCB process allow exceptionally low noise operation $(7.0 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and $0.6 \mathrm{fA} / \sqrt{\mathrm{Hz}}$ ) as well as very high input impedance.
With a wide supply voltage range from 5 V to 24 V , the ability to operate on single supplies, and a bandwidth of 145 MHz , the AD8065/AD8066 are designed to work in a variety of applications. For added versatility, the amplifiers also contain rail-to-rail outputs.

Despite being low cost, the amplifiers provide excellent overall performance. The differential gain and phase errors of 0.02\% and $0.02^{\circ}$, respectively, along with 0.1 dB flatness out to 7 MHz ,
*Protected by U.S. Patent No. 6,262,633
REV.C

## CONNECTION DIAGRAMS



SOIC-8 (R)


SOIC-8 (R)


SOIC-8 (R) and MSOP-8 (RM)

make these amplifiers ideal for video applications. Additionally, they offer a high slew rate of $180 \mathrm{~V} / \mu \mathrm{s}$, excellent distortion (SFDR $-88 \mathrm{~dB} @ 1 \mathrm{MHz}$ ), extremely high common-mode rejection of -100 dB , and a low input offset voltage of 1.5 mV max under warmed up conditions. The AD8065/AD8066 operate using only a $6.4 \mathrm{~mA} /$ amplifier typical supply current, and are capable of delivering up to 30 mA of load current.
The AD8065/AD8066 are high performance, high speed, FET input amplifiers available in small packages: SOIC-8, MSOP, and SOT-23-5. They are rated to work over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.


Figure 1. Small Signal Frequency Response

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.
(@ $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$, unless otherwise noted.)

| Parameter | Conditions | Min | Typ Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE -3 dB Bandwidth <br> Bandwidth for 0.1 dB Flatness Input Overdrive Recovery Time Output Recovery Time Slew Rate Settling Time to $0.1 \%$ | $\begin{aligned} & \mathrm{G}=+1, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p (AD8065) } \\ & \mathrm{G}=+1, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p (AD8066) } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} p-\mathrm{p} \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \text { p-p } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p } \\ & \mathrm{G}=+1,-5.5 \mathrm{~V} \text { to }+5.5 \mathrm{~V} \\ & \mathrm{G}=-1,-5.5 \mathrm{~V} \text { to }+5.5 \mathrm{~V} \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=4 \mathrm{~V} \text { Step } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \text { Step } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=8 \mathrm{~V} \text { Step } \end{aligned}$ | $\begin{aligned} & 100 \\ & 100 \\ & \\ & 130 \end{aligned}$ | 145 <br> 120 <br> 50 <br> 42 <br> 7 <br> 175 <br> 170 <br> 180 <br> 55 <br> 205 | MHz <br> MHz <br> MHz <br> MHz <br> MH <br> ns <br> ns <br> V/ $\mu \mathrm{s}$ <br> ns <br> ns |
| NOISE/HARMONIC PERFORMANCE SFDR <br> Third Order Intercept Input Voltage Noise Input Current Noise Differential Gain Error Differential Phase Error | $\begin{aligned} & \mathrm{f}_{\mathrm{C}}=1 \mathrm{MHz}, \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & \mathrm{f}_{\mathrm{C}}=5 \mathrm{MHz}, \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} p-\mathrm{p} \\ & \mathrm{f}_{\mathrm{C}}=1 \mathrm{MHz}, \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=8 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & \mathrm{f}_{\mathrm{C}}=10 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \text { NTSC, } \mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \text { NTSC, } \mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega \end{aligned}$ |  | $\begin{aligned} & -88 \\ & -67 \\ & -73 \\ & 24 \\ & 7 \\ & 0.6 \\ & 0.02 \\ & 0.02 \end{aligned}$ | dBc <br> dBc <br> dBc <br> dBm <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{fA} / \sqrt{\mathrm{Hz}}$ <br> \% <br> Degree |
| DC PERFORMANCE <br> Input Offset Voltage Input Offset Voltage Drift Input Bias Current Input Offset Current Open-Loop Gain | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \text {, SOIC Package }$ <br> SOIC Package <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ $\mathrm{V}_{\mathrm{O}}= \pm 3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ | 100 | 0.4 1.5 <br> 1 17 <br> 2 6 <br> 25  <br> 1 10 <br> 1  <br> 113  | $\begin{aligned} & \mathrm{mV} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{pA} \\ & \mathrm{pA} \\ & \mathrm{pA} \\ & \mathrm{pA} \\ & \mathrm{~dB} \end{aligned}$ |
| INPUT CHARACTERISTICS <br> Common-Mode Input Impedance <br> Differential Input Impedance <br> Input Common-Mode Voltage Range <br> FET Input Range <br> Usable Range <br> Common-Mode Rejection Ratio | See Theory of Operation section $\mathrm{V}_{\mathrm{CM}}=-1 \mathrm{~V} \text { to }+1 \mathrm{~V}$ <br> $\mathrm{V}_{\mathrm{CM}}=-1 \mathrm{~V}$ to $+1 \mathrm{~V}(\mathrm{SOT}-23)$ | $\begin{aligned} & -5 \text { to }+1.7 \\ & -85 \\ & -82 \end{aligned}$ | $\begin{aligned} & 1000 \\| 2.1 \\ & 1000 \\| 4.5 \\ & \\ & -5.0 \text { to }+2.4 \\ & -5.0 \text { to }+5.0 \\ & -100 \\ & -91 \end{aligned}$ | $\begin{aligned} & \mathrm{G} \Omega \\| \mathrm{pF} \\ & \mathrm{G} \Omega \\| \mathrm{pF} \\ & \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Current <br> Short Circuit Current <br> Capacitive Load Drive | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{~V}_{\mathrm{O}}=9 \mathrm{~V}-\mathrm{p}, \\ & \mathrm{SFDR} \geq-60 \mathrm{dBc}, \mathrm{f}=500 \mathrm{kHz} \\ & \\ & 30 \% \text { Overshoot } \mathrm{G}=+1 \end{aligned}$ | -4.88 to +4.90 | $\begin{aligned} & -4.94 \text { to }+4.95 \\ & -4.8 \text { to }+4.7 \\ & 35 \\ & 90 \\ & 20 \end{aligned}$ | V V <br> mA <br> mA <br> pF |
| POWER SUPPLY <br> Operating Range Quiescent Current per Amplifier Power Supply Rejection Ratio | $\pm$ PSRR | 5 $-85$ | $\begin{array}{ll}  & 24 \\ 6.4 & 7.2 \\ -100 & \end{array}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \end{aligned}$ |

[^0]| Parameter | Conditions | Min | Typ Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> -3 dB Bandwidth <br> Bandwidth for 0.1 dB Flatness Input Overdrive Recovery Output Overdrive Recovery Slew Rate Settling Time to $0.1 \%$ | $\begin{aligned} & \mathrm{G}=+1, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \mathrm{p}-\mathrm{p}(\mathrm{AD} 8065) \\ & \mathrm{G}=+1, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p (AD8066) } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \mathrm{p-p} \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p } \\ & \mathrm{G}=+1,-12.5 \mathrm{~V} \text { to }+12.5 \mathrm{~V} \\ & \mathrm{G}=-1,-12.5 \mathrm{~V} \text { to }+12.5 \mathrm{~V} \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=4 \mathrm{~V} \text { Step } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \text { Step } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=10 \mathrm{~V} \text { Step } \end{aligned}$ | $\begin{aligned} & 100 \\ & 100 \end{aligned}$ $130$ | $\begin{aligned} & 145 \\ & 115 \\ & 50 \\ & 40 \\ & 7 \\ & 175 \\ & 170 \\ & 180 \\ & 55 \\ & 250 \\ & \hline \end{aligned}$ | MHz <br> MHz <br> MHz <br> MHz <br> MHz <br> ns <br> ns <br> V/us <br> ns <br> ns |
| NOISE/HARMONIC PERFORMANCE SFDR <br> Third Order Intercept Input Voltage Noise Input Current Noise Differential Gain Error Differential Phase Error | $\begin{aligned} & \mathrm{f}_{\mathrm{C}}=1 \mathrm{MHz}, \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} p-\mathrm{p} \\ & \mathrm{f}_{\mathrm{C}}=5 \mathrm{MHz}, \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & \mathrm{f}_{\mathrm{C}}=1 \mathrm{MHz}, \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=10 \mathrm{Vp} \mathrm{p} \\ & \mathrm{f}_{\mathrm{C}}=10 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \text { NTSC, } \mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \text { NTSC, } \mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \hline \end{aligned}$ |  | $\begin{aligned} & -100 \\ & -67 \\ & -85 \\ & 24 \\ & 7 \\ & 1 \\ & 0.04 \\ & 0.03 \end{aligned}$ | dBc <br> dBc <br> dBc <br> dBm <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{fA} / \sqrt{\mathrm{Hz}}$ <br> \% <br> Degree |
| DC PERFORMANCE <br> Input Offset Voltage Input Offset Voltage Drift Input Bias Current <br> Input Offset Current Open-Loop Gain | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V} \text {, SOIC Package }$ <br> SOIC Package <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ $\mathrm{V}_{\mathrm{O}}= \pm 10 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ | 103 | 0.4 1.5 <br> 1 17 <br> 3 7 <br> 25  <br> 2 10 <br> 2  <br> 114  <br>   | $\begin{aligned} & \mathrm{mV} \\ & \mu \mathrm{~V} /{ }^{\circ} \mathrm{C} \\ & \mathrm{pA} \\ & \mathrm{pA} \\ & \mathrm{pA} \\ & \mathrm{pA} \\ & \mathrm{~dB} \\ & \hline \end{aligned}$ |
| INPUT CHARACTERISTICS <br> Common-Mode Input Impedance <br> Differential Input Impedance <br> Input Common-Mode Voltage Range <br> FET Input Range <br> Usable Range <br> Common-Mode Rejection Ratio | See Theory of Operation section $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=-1 \mathrm{~V} \text { to }+1 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CM}}=-1 \mathrm{~V} \text { to }+1 \mathrm{~V} \text { (SOT-23) } \end{aligned}$ | $\begin{aligned} & -12 \text { to }+8.5 \\ & -85 \\ & -82 \end{aligned}$ | $\begin{aligned} & 1000 \\| 2.1 \\ & 1000 \\| 4.5 \\ & -12.0 \text { to }+9.5 \\ & -12.0 \text { to }+12.0 \\ & -100 \\ & -91 \end{aligned}$ | $\begin{aligned} & \mathrm{G} \Omega \\| \mathrm{pF} \\ & \mathrm{G} \Omega \\| \mathrm{pF} \\ & \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Current <br> Short Circuit Current <br> Capacitive Load Drive | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=350 \Omega \\ & \mathrm{~V}_{\mathrm{O}}=22 \mathrm{~V} \mathrm{p}-\mathrm{p}, \\ & \mathrm{SFDR} \geq-60 \mathrm{dBc}, \mathrm{f}=500 \mathrm{kHz} \\ & \\ & 30 \% \text { Overshoot } \mathrm{G}=+1 \end{aligned}$ | -11.8 to +11.8 | $\begin{aligned} & -11.9 \text { to }+11.9 \\ & -11.25 \text { to }+11.5 \\ & 30 \\ & 120 \\ & 25 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{pF} \end{aligned}$ |
| POWER SUPPLY <br> Operating Range <br> Quiescent Current per Amplifier <br> Power Supply Rejection Ratio | $\pm$ PSRR | 5 $-84$ | $\begin{array}{cc}  & 24 \\ 6.6 & 7.4 \\ -93 & \end{array}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \end{aligned}$ |

[^1]| Parameter | Conditions | Min | Typ Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> -3 dB Bandwidth <br> Bandwidth for 0.1 dB Flatness Input Overdrive Recovery Time Output Recovery Time Slew Rate Settling Time to $0.1 \%$ | $\begin{aligned} & \mathrm{G}=+1, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p (AD8065) } \\ & \mathrm{G}=+1, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p (AD8066) } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} p-\mathrm{p} \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \text { p-p } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=0.2 \mathrm{~V} \text { p-p } \\ & \mathrm{G}=+1,-0.5 \mathrm{~V} \text { to }+5.5 \mathrm{~V} \\ & \mathrm{G}=-1,-0.5 \mathrm{~V} \text { to }+5.5 \mathrm{~V} \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \text { Step } \\ & \mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \text { Step } \end{aligned}$ | 125 <br> 110 $105$ | $\begin{aligned} & 155 \\ & 130 \\ & 50 \\ & 43 \\ & 6 \\ & 175 \\ & 170 \\ & 160 \\ & 60 \end{aligned}$ | MHz <br> MHz <br> MHz <br> MHz <br> MHz <br> ns <br> ns <br> V/ $\mu \mathrm{s}$ <br> ns |
| NOISE/HARMONIC PERFORMANCE SFDR <br> Third Order Intercept Input Voltage Noise Input Current Noise Differential Gain Error Differential Phase Error | $\begin{aligned} & \mathrm{f}_{\mathrm{C}}=1 \mathrm{MHz}, \mathrm{G}=+2, \mathrm{VO}=2 \mathrm{~V} p-\mathrm{p} \\ & \mathrm{f}_{\mathrm{C}}=5 \mathrm{MHz}, \mathrm{G}=+2, \mathrm{VO}=2 \mathrm{~V} p-\mathrm{p} \\ & \mathrm{f}_{\mathrm{C}}=10 \mathrm{MHz}, \mathrm{R}_{\mathrm{L}}=100 \Omega \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \mathrm{f}=10 \mathrm{kHz} \\ & \text { NTSC, } \mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \text { NTSC, } \mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega \end{aligned}$ |  | $\begin{aligned} & -65 \\ & -50 \\ & 22 \\ & 7 \\ & 0.6 \\ & 0.13 \\ & 0.16 \end{aligned}$ | dBc <br> dBc <br> dBm <br> $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ <br> $\mathrm{fA} / \sqrt{\mathrm{Hz}}$ <br> \% <br> Degree |
| DC PERFORMANCE <br> Input Offset Voltage Input Offset Voltage Drift Input Bias Current Input Offset Current Open-Loop Gain | $\mathrm{V}_{\mathrm{CM}}=1.0 \mathrm{~V} \text {, SOIC Package }$ <br> SOIC Package $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ <br> $\mathrm{V}_{\mathrm{O}}=1 \mathrm{~V}$ to 4 V (AD8065) <br> $\mathrm{V}_{\mathrm{O}}=1 \mathrm{~V}$ to $4 \mathrm{~V}(\mathrm{AD} 8066)$ | $\begin{aligned} & 100 \\ & 90 \end{aligned}$ | 0.4 1.5 <br> 1 17 <br> 1 5 <br> 25  <br> 1 5 <br> 1  <br> 113  <br> 103  | mV <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> pA <br> pA <br> pA <br> pA <br> dB <br> dB |
| INPUT CHARACTERISTICS <br> Common-Mode Input Impedance <br> Differential Input Impedance <br> Input Common-Mode Voltage Range <br> FET Input Range <br> Usable Range <br> Common-Mode Rejection Ratio | See Theory of Operation section $\mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}$ to 4 V <br> $\mathrm{V}_{\mathrm{CM}}=1 \mathrm{~V}$ to 2 V (SOT-23) | 0 to 1.7 $\begin{aligned} & -74 \\ & -78 \end{aligned}$ | $\begin{aligned} & 1000 \\| 2.1 \\ & 1000 \\| 4.5 \\ & \\ & 0 \text { to } 2.4 \\ & 0 \text { to } 5.0 \\ & -100 \\ & -91 \end{aligned}$ | $\begin{aligned} & \mathrm{G} \Omega \\| \mathrm{pF} \\ & \mathrm{G} \Omega \\| \mathrm{pF} \\ & \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Current <br> Short Circuit Current <br> Capacitive Load Drive | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=150 \Omega \\ & \mathrm{~V}_{\mathrm{O}}=4 \mathrm{~V} p-\mathrm{p}, \\ & \mathrm{SFDR} \geq-60 \mathrm{dBc}, \mathrm{f}=500 \mathrm{kHz} \\ & \\ & 30 \% \text { Overshoot } \mathrm{G}=+1 \end{aligned}$ | 0.1 to 4.85 | $\begin{aligned} & 0.03 \text { to } 4.95 \\ & 0.07 \text { to } 4.83 \\ & 35 \\ & 75 \\ & 5 \end{aligned}$ | V <br> V <br> mA <br> mA <br> pF |
| POWER SUPPLY <br> Operating Range Quiescent Current per Amplifier Power Supply Rejection Ratio | $\pm$ PSRR | $\begin{aligned} & 5 \\ & 5.8 \\ & -78 \end{aligned}$ | $\begin{array}{ll}  & 24 \\ 6.4 & 7.0 \\ -100 & \end{array}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \end{aligned}$ $\mathrm{dB}$ |

Specifications subject to change without notice.

## ABSOLUTE MAXIMUM RATINGS*

Supply Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 26.4 V
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . . . . . . See Figure 2 Common-Mode Input Voltage $\ldots \ldots . . \mathrm{V}_{\mathrm{EE}}-0.5 \mathrm{~V}$ to $\mathrm{VCC}+0.5 \mathrm{~V}$ Differential Input Voltage ....................................... . . 1.8 V
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Operating Temperature Range $\ldots \ldots . \ldots . . . . . . .$. Lead Temperature Range (Soldering 10 sec ) ................. $300^{\circ} \mathrm{C}$
*Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## MAXIMUM POWER DISSIPATION

The maximum safe power dissipation in the AD8065/AD8066 packages is limited by the associated rise in junction temperature $\left(\mathrm{T}_{\mathrm{J}}\right)$ on the die. The plastic encapsulating the die will locally reach the junction temperature. At approximately $150^{\circ} \mathrm{C}$, which is the glass transition temperature, the plastic will change its properties. Even temporarily exceeding this temperature limit may change the stresses that the package exerts on the die, permanently shifting the parametric performance of the AD8065 AD8066. Exceeding a junction temperature of $175^{\circ} \mathrm{C}$ for an extended period of time can result in changes in the silicon devices, potentially causing failure.

The still-air thermal properties of the package and PCB $\left(\theta_{J A}\right)$, ambient temperature $\left(T_{A}\right)$, and the total power dissipated in the package $\left(P_{D}\right)$ determine the junction temperature of the die. The junction temperature can be calculated as follows:

$$
T_{J}=T_{A}+\left(P_{D} \times \theta_{J A}\right)
$$

The power dissipated in the package $\left(P_{D}\right)$ is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive for all outputs. The quiescent power is the voltage between the supply pins $\left(V_{S}\right)$ times the quiescent current $\left(I_{S}\right)$. Assuming the load $\left(R_{L}\right)$ is referenced to midsupply, then the total drive power is $V_{S} / 2 \times I_{\text {OUT }}$, some of which is dissipated in the package and some in the load ( $V_{O U T} \times I_{O U T}$ ). The difference between the total drive power and the load power is the drive power dissipated in the package.

$$
\begin{gathered}
P_{D}=\text { quiescent power }+(\text { total drive power }- \text { load power }) \\
P_{D}=\left(V_{S} \times I_{S}\right)+\left(\frac{V_{S}}{2} \times \frac{V_{O U T}}{R_{L}}\right)-\frac{V_{O U T}{ }^{2}}{R_{L}}
\end{gathered}
$$

RMS output voltages should be considered. If $R_{L}$ is referenced to $V_{S^{-}}$, as in single-supply operation, then the total drive power is $V_{S} \times I_{\text {OUT }}$.
If the rms signal levels are indeterminate, then consider the worst case, when $V_{\text {OUT }}=V_{S} / 4$ for $R_{L}$ to midsupply.

$$
P_{D}=\left(V_{S} \times I_{S}\right)+\frac{\left(V_{S} / 4\right)^{2}}{R_{L}}
$$

In single-supply operation with $R_{L}$ referenced to $V_{S^{-}}$, worst case is $V_{\text {OUT }}=V_{S} / 2$.


Figure 2. Maximum Power Dissipation vs. Temperature for a 4-Layer Board
Airflow will increase heat dissipation effectively reducing $\theta_{J A}$. Also, more metal directly in contact with the package leads from metal traces, through holes, ground, and power planes will reduce the $\theta_{J A}$. Care must be taken to minimize parasitic capacitances at the input leads of high speed op amps as discussed in the Layout, Grounding, and Bypass Considerations section.
Figure 2 shows the maximum safe power dissipation in the package versus the ambient temperature for the SOIC-8 $\left(125^{\circ} \mathrm{C} / \mathrm{W}\right)$, SOT-23-5 ( $180^{\circ} \mathrm{C} / \mathrm{W}$ ), and MSOP-8 $\left(150^{\circ} \mathrm{C} / \mathrm{W}\right)$ packages on a JEDEC standard 4-layer board. $\theta_{J A}$ values are approximations.

## OUTPUT SHORT CIRCUIT

Shorting the output to ground or drawing excessive current for the AD8065/AD8066 will likely cause catastrophic failure.

ORDERING GUIDE

| Model | Temperature Range | Package Description | Package <br> Outline | Branding <br> Information |
| :--- | :--- | :--- | :--- | :--- |
| AD8065AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC | R-8 |  |
| AD8065AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC | R-8 |  |
| AD8065AR-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC | R-8 | HRA |
| AD8065ART-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC SOT-23 | RT-5 | HRA |
| AD8065ART-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC SOT-23 | RT-5 | R-8 |
| AD8065AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC | R-8 | R-8 |
| AD8066AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC | R-8 |  |
| AD8066AR-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC | R1B |  |
| AD8066ARM-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC MSOP-8 | RM-8 | H1B |
| AD8066ARM-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC MSOP-8 | RM-8 | H1 |

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8065/AD8066 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.


TPC 1. Small Signal Frequency Response for Various Gains


TPC 2. Small Signal Frequency Response for Various Supplies (See Test Circuit 1)


TPC 3. Large Signal Frequency Response for Various Supplies (See Test Circuit 1)


TPC 4. 0.1 dB Flatness Frequency Response (See Test Circuit 2)


TPC 5. Small Signal Frequency Response for Various Supplies (See Test Circuit 2)


TPC 6. Large Signal Frequency Response for Various Supplies (See Test Circuit 2)
$\square$
AD8065/AD8066


TPC 7. Small Signal Frequency Response for Various C LOAD (See Test Circuit 1)


TPC 8. Frequency Response for Various Output Amplitudes (See Test Circuit 2)


TPC 9. Small Signal Frequency Response for Various $R_{F} / C_{F}$ (See Test Circuit 2)


TPC 10. Small Signal Frequency Response for Various C LOAD (See Test Circuit 2)


TPC 11. Small Signal Frequency Response for Various $R_{\text {LOAD }}$ (See Test Circuit 2)


TPC 12. Open-Loop Response


TPC 13. Harmonic Distortion vs. Frequency for Various Loads (See Test Circuit 2)


TPC 14. Harmonic Distortion vs. Amplitude for Various Loads VS $= \pm 12$ V (See Test Circuit 2)


TPC 15. Third Order Intercept vs. Frequency and Supply Voltage


TPC 16. Harmonic Distortion vs. Frequency for Various Gains (See Test Circuits 1 and 2)


TPC 17. Harmonic Distortion vs. Frequency for Various Amplitudes (See Test Circuit 2)


TPC 18. Voltage Noise

## AD8065/AD8066



TPC 19. Small Signal Transient Response 5 V Supply (See Test Circuit 11)


TPC 20. Large Signal Transient Response (See Test Circuit 1)


TPC 21. Output Overdrive Recovery (See Test Circuit 3), $V_{S}= \pm 5 \mathrm{~V}$


TPC 22. Small Signal Transient Response $\pm 5 \mathrm{~V}$ (See Test Circuit 1)


TPC 23. Large Signal Transient Response (See Test Circuit 2)


TPC 24. Input Overdrive Recovery (See Test Circuit 1), $V_{S}= \pm 5 \mathrm{~V}$


TPC 25. Long-Term Settling Time (See Test Circuit 8)


TPC 26. Input Bias Current vs. Temperature


TPC 27. Input Offset Voltage vs. Common-Mode Voltage


TPC 28. 0.1\% Short-Term Settling Time (See Test Circuit 8)


TPC 29. Input Bias Current vs. Common-Mode Voltage Range*


TPC 30. Input Offset Voltage
$\square$ $\square$ AD8065/AD8066


TPC 31. CMRR vs. Frequency (See Test Circuit 5)


TPC 32. Output Saturation Voltage vs. Output Load Current


TPC 33. PSRR vs. Frequency (See Test Circuits 7 and 9)


TPC 34. Output Impedance vs. Frequency (See Test Circuits 4 and 6)


TPC 35. Output Saturation Voltage vs. Temperature


TPC 36. Crosstalk vs. Frequency (See Test Circuit 10)


TPC 37. Quiescent Supply Current vs. Temperature for Various Supply Voltages


TPC 38. Open-Loop Gain vs. Load Current for Various Supply Voltages

## Test Circuits

SOIC Pinout


Test Circuit 1. $G=+1$


Test Circuit 2. $G=+2$


Test Circuit 3. $G=-1$


Test Circuit 4. Output Impedance $G=+1$


Test Circuit 5. CMRR


Test Circuit 6. Output Impedance $G=+2$

## AD8065/AD8066



Test Circuit 7. Positive PSRR


Test Circuit 8. Settling Time


Test Circuit 9. Negative PSRR


Test Circuit 10. Crosstalk - AD8066


Test Circuit 11. Single Supply

## AD8065/AD8066

## THEORY OF OPERATION

The AD8065/AD8066 are voltage feedback operational amplifiers that combine a laser-trimmed JFET input stage with Analog Devices' eXtra Fast Complementary Bipolar process, resulting in an outstanding combination of precision and speed. Supply voltage range is from 5 V to 24 V . The amplifiers feature a patented rail-to-rail output stage capable of driving within 0.5 V of either power supply while sourcing or sinking up to 30 mA . Also featured is a single-supply input stage that handles common-mode signals from below the negative supply to within 3 V of the positive rail. Operation beyond the JFET input range is possible because of an auxiliary bipolar input stage that functions with input voltages up to the positive supply. The amplifiers operate as if they have a rail-to-rail input and exhibit no phase reversal behavior for commonmode voltages within the power supply.
With voltage noise of $7 \mathrm{nV} / \sqrt{\mathrm{Hz}}$ and -88 dBc distortion for 1 MHz 2 V p-p signals, the AD8065/AD8066 are a great choice for high resolution data acquisition systems. Their low noise, sub-pA input current, precision offset, and high speed make them a superb preamps for fast photodiode applications. The speed and output drive capability of the AD8065/AD8066 also make them useful in video applications.

## Closed-Loop Frequency Response

The AD8065/AD8066 are classic voltage feedback amplifiers with an open-loop frequency response that can be approximated as the integrator response shown in Figure 3. Basic closed-loop frequency response for inverting and noninverting configurations can be derived from the schematics shown.

## Noninverting Closed-Loop Frequency Response

Solving for the transfer function

$$
\frac{V_{O}}{V_{I}}=\frac{2 \pi \times f_{\text {crossover }}\left(R_{G}+R_{F}\right)}{\left(R_{F}+R_{G}\right) s+2 \pi \times f_{\text {crossover }} \times R_{G}}
$$

where $f_{\text {crossover }}$ is the frequency where the amplifier's open-loop gain equals 0 db .

At dc

$$
\frac{V_{O}}{V_{I}}=\frac{R_{F}+R_{G}}{R_{G}}
$$

Closed-loop -3 dB frequency

$$
f_{-3 d B}=f_{\text {crossover }} \times \frac{R_{G}}{R_{F}+R_{G}}
$$

## Inverting Closed-Loop Frequency Response

$$
\frac{V_{O}}{V_{I}}=\frac{-2 \pi \times f_{\text {crossover }} \times R_{F}}{s\left(R_{F}+R_{G}\right)+2 \pi \times f_{\text {crossover }} \times R_{G}}
$$

At dc

$$
\frac{V_{O}}{V_{I}}=-\frac{R_{F}}{R_{G}}
$$

Closed-loop -3 dB frequency

$$
f_{-3 d B}=f_{\text {crossover }} \times \frac{R_{G}}{R_{F}+R_{G}}
$$



Figure 3. Open Look Gain vs. Frequency and Basic Connections

The closed-loop bandwidth is inversely proportional to the noise gain of the op amp circuit, $\left(R_{F}+R_{G}\right) / R_{G}$. This simple model is accurate for noise gains above 2. The actual bandwidth of circuits with noise gains at or below 2 will be higher than those predicted with this model due to the influence of other poles in the frequency response of the real op amp.


Figure 4. Voltage Feedback Amplifier DC Errors
Figure 4 shows a voltage feedback amplifier's dc errors. For both inverting and noninverting configurations

$$
V_{O}(\text { error })=I_{b+} \times R_{S}\left(\frac{R_{G}+R_{F}}{R_{G}}\right)-I_{b-} \times R_{F}+V_{O S}\left(\frac{R_{G}+R_{F}}{R_{G}}\right)
$$

The voltage error due to $I_{b+}$ and $I_{b-}$ is minimized if $R_{S}=R_{F} \| R_{G}$ (though with the AD8065 input currents at less than 20 pA over temperature, this is likely not a concern). To include commonmode and power supply rejection effects, total $V_{O S}$ can be modeled as

$$
V_{O S}=V_{O S_{n o m}}+\frac{\Delta V_{S}}{P S R}+\frac{\Delta V_{C M}}{C M R}
$$

$V_{O S_{\text {nom }}}$ is the offset voltage specified at nominal conditions. $\Delta V_{S}$ is the change in power supply from nominal conditions. $P S R$ is the power supply rejection. $\Delta V_{C M}$ is the change in common-mode voltage from nominal conditions. $C M R$ is the common-mode rejection.

## Wideband Operation

Test Circuits 1, 2, and 3 show the circuits used for wideband characterization for gains of $+1,+2$, and -1 . Source impedance at the summing junction $\left(R_{F} \| R_{G}\right)$ will form a pole in the amplifier's loop response with the amplifier's input capacitance of 6.6 pF . This can cause peaking and ringing if the time constant formed is too low. Feedback resistances of $300 \Omega$ to $1 \mathrm{k} \Omega$ are recommended, since they will not unduly load down the amplifier and the time constant formed will not be too low. Peaking in the frequency response can be compensated with a small capacitor $\left(C_{F}\right)$ in parallel with the feedback resistor, as illustrated in TPC 9 . This shows the effect of different feedback capacitances on the peaking and bandwidth for a noninverting $\mathrm{G}=+2$ amplifier.
For the best settling times and the best distortion, the impedances at the AD8065/AD8066 input terminals should be matched. This minimizes nonlinear common-mode capacitive effects that can degrade ac performance.
Actual distortion performance depends on a number of variables:

- The closed-loop gain of the application
- Whether it is inverting or noninverting
- Amplifier loading
- Signal frequency and amplitude
- Board layout

Also see TPCs 13 to 17. The lowest distortion will be obtained with the AD8065 used in low gain inverting applications, since this eliminates common-mode effects. Higher closed-loop gains result in worse distortion performance.

## Input Protection

The inputs of the AD8065/AD8066 are protected with back-toback diodes between the input terminals as well as ESD diodes to either power supply. This results in an input stage with picoamps of input current that can withstand up to 1500 V ESD events (human body model) with no degradation.
Excessive power dissipation through the protection devices will destroy or degrade the performance of the amplifier. Differential voltages greater than 0.7 V will result in an input current of approximately $\left(\left|V_{+}-V_{-}\right|-0.7 V\right) / R_{I}$, where $R_{I}$ is the resistance in series with the inputs. For input voltages beyond the positive supply, the input current will be approximately $\left(\mathrm{V}_{\mathrm{I}}-\mathrm{V}_{\mathrm{CC}}-0.7\right) / R_{I}$. Beyond the negative supply, the input current will be about $\left(\mathrm{V}_{\mathrm{I}}-\mathrm{V}_{\mathrm{EE}}+0.7\right) / R_{I}$. If the inputs of the amplifier are to be subjected to sustained differential voltages greater than 0.7 V or to input voltages beyond the amplifier power supply, input current should be limited to 30 mA by an appropriately sized input resistor $\left(R_{I}\right)$ as shown in Figure 5.


Figure 5. Current Limiting Resistor

## Thermal Considerations

With 24 V power supplies and 6.5 mA quiescent current, the AD8065 dissipates 156 mW with no load. The AD8065/AD8066 dissipate 312 mW . This can lead to noticeable thermal effects, especially in the small SOT-23-5 (thermal resistance of $160^{\circ} \mathrm{C} / \mathrm{W}$ ). $V_{O S}$ temperature drift is trimmed to guarantee a max drift of $17 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$, so it can change up to 0.425 mV due to warm-up effects for an AD8065/AD8066 in a SOT-23-5 package on 24 V .
$I_{b}$ increases by a factor of 1.7 for every $10^{\circ} \mathrm{C}$ rise in temperature. $I_{b}$ will be close to 5 times higher at 24 V supplies as opposed to a single 5 V supply.
Heavy loads will increase power dissipation and raise the chip junction temperature as described in the Maximum Power Dissipation section. Care should be taken to not exceed the rated power dissipation of the package.

## AD8065/AD8066

## Input and Output Overload Behavior

The AD8065/AD8066 have internal circuitry to guard against phase reversal due to overdriving the input stage. A simplified schematic of the input stage, including the input-protection diodes and antiphase reversal circuitry, is shown in Figure 6.

The circuit is arranged such that when the input common-mode voltage exceeds a certain threshold, the input JFET pair's bias current will turn OFF, and the bias current of an auxiliary NPN pair will turn ON, taking over control of the amplifier. When the input common-mode voltage returns to a viable operating value, the FET stage turns back ON, the NPN stage turns OFF, and normal operation resumes.

The NPN pair can sustain operation with the input voltage up to the positive supply, so this is a pseudo rail-to-rail input stage. For operation beyond the FET stage's common-mode limit, the amplifier's $V_{O S}$ will change to the NPN pair's offset (mean of $160 \mu \mathrm{~V}$, standard deviation of $820 \mu \mathrm{~V}$ ), and $I_{b}$ will increase to the NPN pair's base current up to $45 \mu \mathrm{~A}$ (see TPC 29).

Switchback, or recovery time, is about 100 ns , as shown in TPC 24. The output transistors of the rail-to-rail output stage have circuitry to limit the extent of their saturation when the output is overdriven. This helps output recovery time. Output recovery from a 0.5 V output overdrive on a $\pm 5 \mathrm{~V}$ supply is shown in TPC 21 .

## LAYOUT, GROUNDING, AND BYPASSING CONSIDERATIONS <br> Power Supply Bypassing

Power supply pins are actually inputs and care must be taken so that a noise-free stable dc voltage is applied. The purpose of bypass capacitors is to create low impedances from the supply to ground at all frequencies, thereby shunting or filtering most of the noise.
Decoupling schemes are designed to minimize the bypassing impedance at all frequencies with a parallel combination of capacitors. $0.1 \mu \mathrm{~F}$ (X7R or NPO) chip capacitors are critical and should be as close as possible to the amplifier package. The $4.7 \mu \mathrm{~F}$ tantalum capacitor is less critical for high frequency bypassing, and in most cases, only one is needed per board, at the supply inputs.

## Grounding

A ground plane layer is important in densely packed PC boards to spread the current minimizing parasitic inductances. However, an understanding of where the current flows in a circuit is critical to implementing effective high speed circuit design. The length of the current path is directly proportional to the magnitude of parasitic inductances and therefore the high frequency impedance of the path. High speed currents in an inductive ground return will create an unwanted voltage noise.


Figure 6. Simplified Input Stage

The length of the high frequency bypass capacitor leads is most critical. A parasitic inductance in the bypass grounding will work against the low impedance created by the bypass capacitor. Place the ground leads of the bypass capacitors at the same physical location. Because load currents flow from the supplies as well, the ground for the load impedance should be at the same physical location as the bypass capacitor grounds. For the larger value capacitors, which are intended to be effective at lower frequencies, the current return path distance is less critical.

## Leakage Currents

Poor PC board layout, contaminants, and the board insulator material can create leakage currents that are much larger than the input bias current of the AD8065/AD8066. Any voltage differential between the inputs and nearby runs will set up leakage currents through the PC board insulator, for example, $1 \mathrm{~V} / 100 \mathrm{G} \Omega=10 \mathrm{pA}$. Similarly, any contaminants on the board can create significant leakage (skin oils are a common problem). To significantly reduce leakages, put a guard ring (shield) around the inputs and input leads that are driven to the same voltage potential as the inputs. This way there is no voltage potential between the inputs and surrounding area to set up any leakage currents. For the guard ring to be completely effective, it must be driven by a relatively low impedance source and should completely surround the input leads on all sides, above and below, using a multilayer board.
Another effect that can cause leakage currents is the charge absorption of the insulator material itself. Minimizing the amount of material between the input leads and the guard ring will help to reduce the absorption. Also, low absorption materials, such as Teflon ${ }^{\circledR}$ or ceramic, may be necessary in some instances.

## Input Capacitance

Along with bypassing and ground, high speed amplifiers can be sensitive to parasitic capacitance between the inputs and ground. A few pF of capacitance will reduce the input impedance at high frequencies, in turn increasing the amplifier's gain, causing peaking of the frequency response or even oscillations, if severe enough. It is recommended that the external passive components connected to the input pins be placed as close as possible to the inputs to avoid parasitic capacitance. The ground and power planes must be kept at a small distance from the input pins on all layers of the board.

## Output Capacitance

To a lesser extent, parasitic capacitances on the output can cause peaking and ringing of the frequency response. There are two methods to effectively minimize their effect.

1) As shown in Figure 7, put a small value resistor $\left(R_{S}\right)$ in series with the output to isolate the load capacitor from the amp's output stage. A good value to choose is $20 \Omega$ (see TPC 7).


Figure 7. Output Isolation Resistor
2) Increase the phase margin with higher noise gains or add a pole with a parallel resistor and capacitor from -IN to the output.


Figure 8. Wideband Photodiode Preamp

## AD8065/AD8066

## Input-to-Output Coupling

In order to minimize capacitive coupling between the inputs and output, the output signal traces should not be parallel with inputs.

## Wideband Photodiode Preamp

Figure 8 shows an I/V converter with an electrical model of a photodiode. The basic transfer function is where

$$
V_{\text {OUT }}=\frac{I_{\text {PHOTO }} \times R_{F}}{1+s C_{F} R_{F}}
$$

$I_{\text {РНото }}$ is the output current of the photodiode and the parallel combination of $R_{F}$ and $C_{F}$ set the signal bandwidth.

The stable bandwidth attainable with this preamp is a function of $R_{F}$, the gain bandwidth product of the amplifier, and the total capacitance at the amplifier's summing junction, including $C_{S}$ and the amplifier input capacitance. $R_{F}$ and the total capacitance produce a pole in the amplifier's loop transmission that can result in peaking and instability. Adding $C_{F}$ creates a zero in the loop transmission that compensates for the pole's effect and reduces the signal bandwidth. It can be shown that the signal bandwidth resulting in a $45^{\circ}$ phase margin $\left(f_{(45)}\right)$ is defined by the expression

$$
f_{(45)}=\sqrt{\frac{f_{C R}}{2 \pi \times R_{F} \times C_{S}}}
$$

where:
$f_{C R}$ is the the amplifier crossover frequency.
$R_{F}$ is the feedback resistor.
$C_{S}$ is the total capacitance at the amplifier summing junction (amplifier + photodiode + board parasitics).
The value of $C_{F}$ that produces $f_{(45)}$ can be shown to be

$$
C_{F}=\sqrt{\frac{C_{S}}{2 \pi \times R_{F} \times f_{C R}}}
$$

The frequency response in this case will show about 2 dB of peaking and $15 \%$ overshoot. Doubling $C_{F}$ and cutting the bandwidth in half will result in a flat frequency response, with about 5\% transient overshoot.

The preamp's output noise over frequency is shown in Figure 9.


Figure 9. Photodiode Voltage Noise Contributions
The pole in the loop transmission translates to a zero in the amplifier's noise gain, leading to an amplification of the input voltage noise over frequency. The loop transmission zero introduced by $C_{F}$ limits the amplification. The noise gain's bandwidth extends past the preamp signal bandwidth and is eventually rolled off by the decreasing loop gain of the amplifier. Keeping the input terminal impedances matched is recommended to eliminate common-mode noise peaking effects, which will add to the output noise.
Integrating the square of the output voltage noise spectral density over frequency and then taking the square root allows users to obtain the total rms output noise of the preamp. Table I summarizes approximations for the amplifier and feedback and source resistances. Noise components for an example preamp with $R_{F}=50 \mathrm{k} \Omega, C_{S}=15 \mathrm{pF}$, and $C_{F}=2 \mathrm{pF}$ (bandwidth of about 1.6 MHz) are also listed.

Table 1. RMS Noise Contributions of Photodiode Preamp

| Contributor | Expression | RMS Noise with $\mathbf{R}_{\mathbf{F}}=50 \mathrm{k} \Omega$ <br> $\mathbf{C}_{\mathbf{S}}=15 \mathbf{p F}, \mathbf{C}_{\mathbf{S}}=15 \mathbf{p F}$ |
| :--- | :--- | :--- |
| $\mathrm{R}_{\mathrm{F}}(\times 2)$ | $\sqrt{2 \times 4 k T \times R_{F} \times f_{2} \times 1.57}$ | $64.5 \mu \mathrm{~V}$ |
| Amp to $\mathrm{f}_{1}$ | ven $\times \sqrt{f_{1}}$ | $2.4 \mu \mathrm{~V}$ |
| Amp $\left(\mathrm{f}_{1} \mathrm{f}_{1}\right)$ | $v e n \times \sqrt{\frac{\left(C_{S}+C_{M}+C_{F}+2 C_{D}\right)}{C_{F}}} \times \sqrt{f_{2}-f_{1}}$ | $31 \mu \mathrm{~V}$ |
| Amp to (past $\left.\mathrm{f}_{2}\right)$ | ven $\times \sqrt{\frac{\left(C_{S}+C_{M}+C_{D}+2 C_{F}\right)}{C_{F}}} \times \sqrt{f_{3} \times 1.57}$ |  |



Figure 10. High Speed Instrumentation Amplifier

## High Speed JFET Input Instrumentation Amplifier

Figure 10 shows an example of a high speed instrumentation amplifier with high input impedance using the AD8065/AD8066. The dc transfer function is

$$
V_{\text {OUT }}=\left(V_{N}-V_{P}\right)\left(\frac{1+1000}{R_{G}}\right)
$$

For $G=+1$, it is recommended that the feedback resistors for the two preamps be set to a low value (for instance $50 \Omega$ for $50 \Omega$ source impedance). The bandwidth for $\mathrm{G}=+1$ will be 50 MHz . For higher gains, the bandwidth will be set by the preamp, equaling

$$
\text { Inamp }_{-3 d B}=\left(f_{C R} \times R_{G}\right) /\left(2 \times R_{F}\right)
$$

Common-mode rejection of the inamp will be primarily determined by the match of the resistor ratios R1:R2 to R3:R4. It can be estimated

$$
\frac{V_{O}}{V_{C M}}=\frac{(\delta 1-\delta 2)}{(1+\delta 1) \delta 2}
$$

The summing junction impedance for the preamps is equal to $\mathrm{R}_{\mathrm{F}} \| 0.5\left(R_{G}\right)$. This is the value to be used for matching purposes.

## Video Buffer

The output current capability and speed of the AD8065 make it useful as a video buffer, shown in Figure 11.
The $G=+2$ configuration compensates for the voltage division of the signal due to the signal termination. This buffer maintains 0.1 dB flatness for signals up to 7 MHz , from low amplitudes up to 2 V p-p (TPC 4). Differential gain and phase have been measured to be $0.02 \%$ and $0.028^{\circ}$ at $\pm 5 \mathrm{~V}$ supplies.


Figure 11. Video Buffer

## OUTLINE DIMENSIONS

## 8-Lead Standard Small Outline Package (SOIC) <br> Narrow Body <br> (R-8)

Dimensions shown in millimeters and (inches)


COMPLIANT TO JEDEC STANDARDS MS-012AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

5-Lead Plastic Surface Mount Package (SOT-23)
(RT-5)
Dimensions shown in millimeters


COMPLIANT TO JEDEC STANDARDS MO-178AA

8-Lead MicroSOIC Package (MSOP)
(RM-8)
Dimensions shown in millimeters


COMPLIANT TO JEDEC STANDARDS MO-187AA

## Revision History

Location ..... Page
4/03-Data Sheet changed from REV. B to REV. C.
Added SOIC-8 (R) for the AD8065 ..... 4
2/03-Data Sheet changed from REV. A to REV. B.
Changes to ABSOLUTE MAXIMUM RATINGS ..... 4
Changes to Test Circuit 10 ..... 14
Changes to Test Circuit 11 ..... 15
Changes to Noninverting Closed-Loop Frequency Response ..... 16
Changes to Inverting Closed-Loop Frequency Response ..... 16
Updated Figure 6 ..... 18
Changes to Figure 7 ..... 19
Changes to Figures 10 ..... 21
Changes to Figure 11 ..... 22
Changes to High Speed JFET Instrumentation Amplifier ..... 22
Changes to Video Buffer ..... 22
8/02-Data Sheet changed from REV. 0 to REV. A.
Added AD8066 ..... Universal
Added SOIC-8 (R) and MSOP-8 (RM) ..... 1
Edits to GENERAL DESCRIPTION ..... 1
Edits to SPECIFICATIONS ..... 2
New Figure 2 ..... 5
Changes to ORDERING GUIDE ..... 5
Edits to TPCs 18, 25, and 28 ..... 8
New TPC 36 ..... 11
Added Test Circuits 10 and 11 ..... 14
MSOP (RM-8) added ..... 23


[^0]:    Specifications subject to change without notice.

[^1]:    Specifications subject to change without notice.

